



Doc. Number :					
☐Tentative Specification					
☐ Preliminary Specification					
Approval Specification					

MODEL NO.: M236HJJ SUFFIX: L30

Customer:	
APPROVED BY	SIGNATURE
Name / Title Note Product Version C1	
Please return 1 copy for you signature and comments.	ur confirmation with your

Approved By	Checked By	Prepared By
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REVISION HISTORY

Version	Date	Page	Description
1.0	Dec./2013		
1.1	Feb.2014		Preliminary spec was first issued.
		5	Power Consumption
		6	BACKLIGHT UNIT
		11	BACKLIGHT UNIT
		17	Timing Specifications
		18	LED Light Bar Test Converter
2.0	April.2014	5	MECHANICAL SPECIFICATIONS(tolerance change)
			OPTICAL CHARACTERISTICS Response Time

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1. GENERAL DESCRIPTION

1.1 OVERVIEW

M236HJJ-L30 is a 23.6" TFT Liquid Crystal Display module white-LED back-light unit and 30 pins 2 channels LVDS interface. This module supports 1920x1080 native resolutions and can display up to 16.7 millions colors. The converter module for Backlight is not built in.

1.2 GENERAL SPECIFICATIONS

Item	Specification	Unit	Not e
Active Area Size	23.6" real diagonal		
Driver Element	a-si TFT active matrix	-	
Pixel Number	1920 x R.G.B. x 1080	pixel	
Pixel Pitch	0.2715(H) x 0.2715(V)	mm	
Pixel Arrangement	RGB vertical stripe	-	
Display Colors	16.7M	color	
Transmissive Mode	Normally black	-	
Luminance, White	250	cd/m ² -	
Color Gamut	72% of NTSC(Typ.)	-	
TCO	TC0 6.0	-	
Surface Treatment	AG type, 3H hard coating, Haze :3.0 ±1.0%	(1)	
Power Consumption	Total(20.3Max)W@ cell (7)W, BL(13.3) (W)		

Note (1) The specified power consumption: Total= cell(reference 4.3.1)+BL(reference 4.3.3)

2. MECHANICAL SPECIFICATIONS

Item		Min.	Тур.	Max.	Unit	Note
	Horizontal	544.3	544.8	545.3	mm	
Module Size	Vertical	320	320.5	321	mm	(1)
	Thickness	10.5	11	11.5	mm	
Bezel Area	Horizontal	524.92	525.22	525.52	mm	
	Vertical	296.92	297.22	297.52	mm	
Active Area	Horizontal	-	521.28	-		
	Vertical	-	293.22	-	mm	
Weight		2195	2305	2415		

Note (1) Please refer to the attached drawings for more information of front and back outline dimensions.

3. ABSOLUTE MAXIMUM RATINGS

3.1 ABSOLUTE RATINGS OF ENVIRONMENT

Item	Symbol	Va	Unit	Note		
item	Cyllibol	Min.	Max.	Offic	INOLE	
Storage Temperature	TST	-20	60	ōC	(1)	
Operating Ambient Temperature	TOP	0	50	ōC	(1), (2)	

Note (1)

(a) 90 %RH Max. ($Ta < 40 \, {}^{\circ}C$).

(b) Wet-bulb temperature should be Ta < 40 °C

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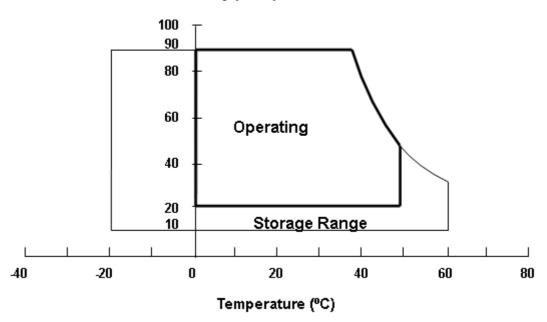




(c) No condensation.

Note (2) Panel surface temperature should be 0° C min. and 65° C max under Vcc=5.0V, fr =60Hz, typical LED string current, 25° C ambient temperature, and no humidity control . Any condition of ambient operating temperature ,the surface of active area should be keeping not higher than 65° C.





3.2 ELECTRICAL ABSOLUTE RATINGS

3.2.1 TFT-LCD MODULE

ltem	Item Symbol		lue	Unit	Note	
item	Cymbol	Min.	Max.	0111	14010	
Power Supply Voltage	VCCS	-0.3	6.0	V	(1)	
Logic Input Voltage	V _{IN}	-0.3	3.6	V	(1)	

3.2.2 BACKLIGHT UNIT

Item	Symbol	Value			Unit	Note
Itom	Cyllibol	Min.	Тур	Max.	Orne	14010
LED Forward Current Per Input Pin	l _F		95	110	mA	(1), (2) Duty=100%
LED Pulse Forward Current Per Input Pin	lР			150	mA	(1), (2) Pulse Width≦10msec. and Duty≦30%

- Note (1) Permanent damage to the device may occur if maximum values are exceeded. Function operation should be restricted to the conditions described under Normal Operating Conditions.
- Note (2) Specified values are for input pin of LED light bar at Ta=25 \pm 2 $^{\circ}$ C (Refer to 4.3.3 and 4.3.4 for further information).

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4. ELECTRICAL SPECIFICATIONS4.1 FUNCTION BLOCK DIAGRAM

4.1 FUNCTION BLOCK DIAGRAM

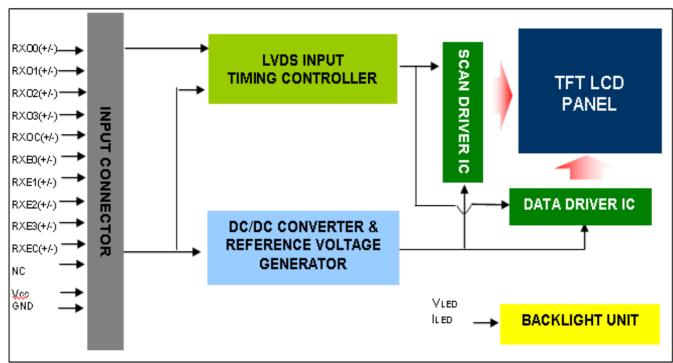


Fig. 4-1 Module Function Block Diagram

4.2. INTERFACE CONNECTIONS

4.2.1 Module LCD PIN ASSIGNMENT

Pin	Name	Description
1	RXO0-	Negative LVDS differential data input. Channel O0 (odd)
2	RXO0+	Positive LVDS differential data input. Channel O0 (odd)
3	RXO1-	Negative LVDS differential data input. Channel O1 (odd)
4	RXO1+	Positive LVDS differential data input. Channel O1 (odd)
5	RXO2-	Negative LVDS differential data input. Channel O2 (odd)
6	RXO2+	Positive LVDS differential data input. Channel O2 (odd)
7	GND	Ground
8	RXOC-	Negative LVDS differential clock input. (odd)
9	RXOC+	Positive LVDS differential clock input. (odd)
10	RXO3-	Negative LVDS differential data input. Channel O3(odd)
11	RXO3+	Positive LVDS differential data input. Channel O3 (odd)
12	RXE0-	Negative LVDS differential data input. Channel E0 (even)
13	RXE0+	Positive LVDS differential data input. Channel E0 (even)
14	GND	Ground
15	RXE1-	Negative LVDS differential data input. Channel E1 (even)
16	RXE1+	Positive LVDS differential data input. Channel E1 (even)
17	GND	Ground
18	RXE2-	Negative LVDS differential data input. Channel E2 (even)
19	RXE2+	Positive LVDS differential data input. Channel E2 (even)
20	RXEC-	Negative LVDS differential clock input. (even)
21	RXEC+	Positive LVDS differential clock input. (even)
22	RXE3-	Negative LVDS differential data input. Channel E3 (even)
23	RXE3+	Positive LVDS differential data input. Channel E3 (even)

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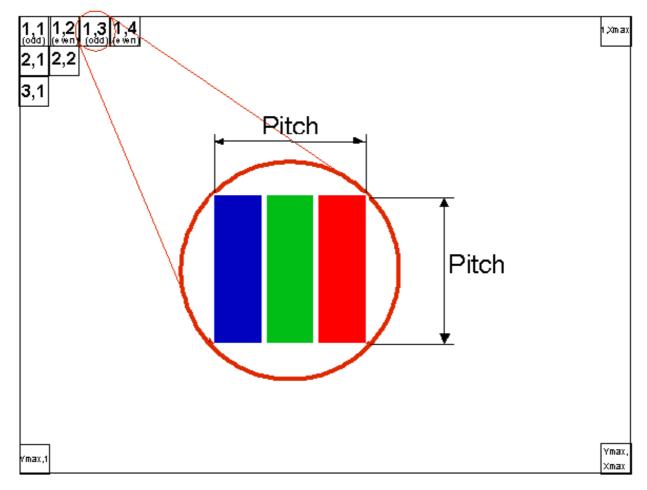
24	GND	Ground				
25	NC	For LCD internal use only, Do not connect				
26	NC	For LCD internal use only, Do not connect				
27	NC	For LCD internal use only, Do not connect				
28	Vcc	+5.0V power supply				
29	Vcc	+5.0V power supply				
30	Vcc	+5.0V power supply				

4.2.2 Module Panel Connector Information

Item	Description
Manufacturer	P-TWO
Type part number	P-TWO:187098-30091
Mating housing part number	FI-X30H(JAE)

Note (1) The first pixel is odd

Note (2) Input signal of even and odd clock should be the same timing.



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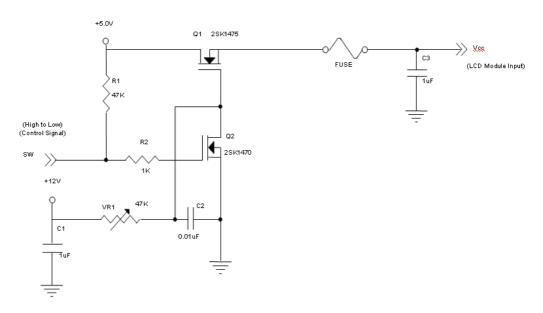
4.3 ELECTRICAL CHARACTERISTICS

4.3.1 LCD ELETRONICS SPECIFICATION

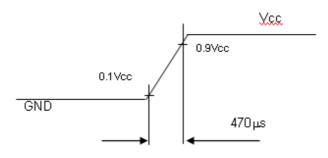
	Dava	1	C. was bas l		Value		l lock	Nata	
	Parame	eter	Symbol	Min.	Тур.	Max.	Unit	Note	
	Power Supply	/ Voltage	Vcc	4.5	5.0	5.5	V	-	
	Ripple Vo	Itage	V_{RP}	-	-	300	mV	-	
	Rush Cu	rrent	I _{RUSH}	-	-	3	Α	(2)	
		White	-	-	1.18	1.4	Α	(3)a	
Power Sup	oply Current	Black	-	-	0.83	0.97	Α	(3)b	
		Vertical Stripe	-	-	1.18	1.4	Α	(3)c	
	Power Cons	umption	PLCD	-	5.7	7	Watt	(4)	
	Different	ial Input Voltage	V_{ID}	100	-	600	mV		
	Commo	n Input Voltage	V_{CM}	1.0	1.2	1.4	V		
LVDS interface		ntial Input High shold Voltage	V _{TH}	-	-	+100	mV		
		ntial Input Low shold Voltage	V _{TL}	-100	-	-	mV		

Note (1) The ambient temperature is $Ta = 25 \pm 2$ $^{\circ}C$.

Note (2) Measurement Conditions:



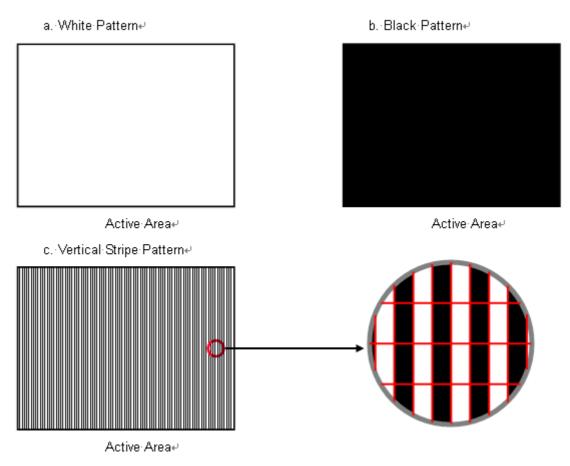
Vcc rising time is 470µs



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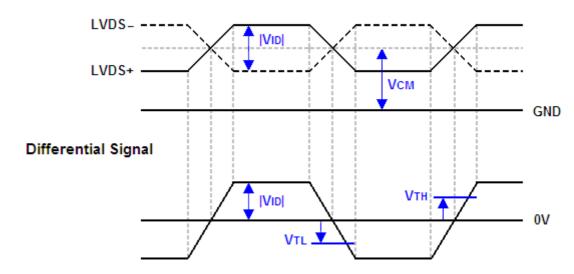
Note (3) The specified power supply current is under the conditions at Vcc = 5.0 V, $Ta = 25 \pm 2 \,^{\circ}\text{C}$, Fr = 60 Hz, whereas a power dissipation check pattern below is displayed.



Note (4) The power consumption is specified at the pattern with the maximum current.

Note (5) The LVDS input characteristics are as follows:

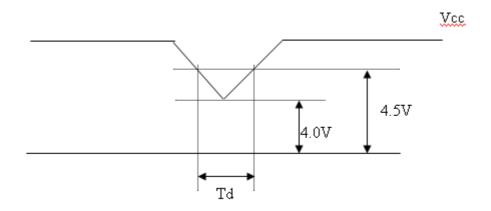
Single-end Signals



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4.3.2 Vcc Power Dip Condition



Dip condition: $4.0 \le Vcc \le 4.5$, $Td \le 20ms$

4.3.3 BACKLIGHT UNIT

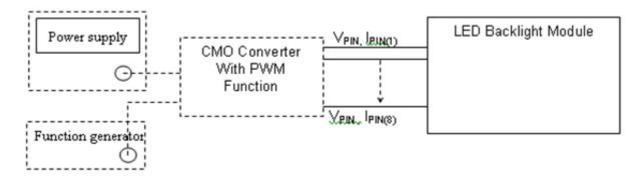
Parameter	Symb		Value		Uni	Note
i didilietei	ol	Min.	Тур.	Max.	t	Note
LED Light Bar Input Voltage Per Input Pin	VPIN		31.0	35.0	V	(1), Duty=100%, IPIN=95mA
LED Light Bar Current Per Input Pin	IPIN		95	110	mA	(1), (2) Duty=100%
LED Life Time	LLED	30000			Hrs	(3)
Power Consumption	PBL		11.78	13.30	W	(1) Duty=100%, IPIN=95mA

Note (1) LED light bar input voltage and current are measured by utilizing a true RMS multimeter as shown below:

Note (2) PBL (Typ) = $IPIN(Typ) \times VPIN(Typ) \times (4) PBL(Max) = IPIN(Typ) \times VPIN(Max)x(4) input pins$,

Note (3) The lifetime of LED is defined as the time when LED packages continue to operate under the conditions at Ta = 25 \pm 2 $^{\circ}$ C and I= (95)mA (per chip) until the brightness becomes \leq 50% of its original value.

Note (4) The module must be operated with constant driving current.

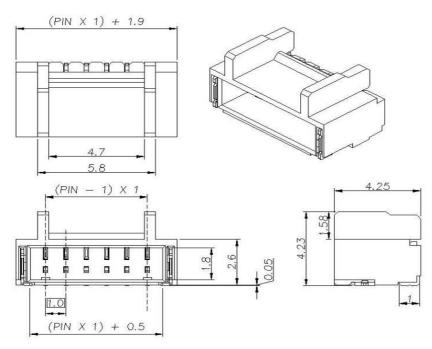


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4.3.4 LIGHTBAR Connector Pin Assignment

(1) Connector Information:



Pin number	Description				
1	LED1 negative polarity				
2	LED2 negative polarity				
3	Input voltage Power Supply				
4	Input voltage Power Supply				
5	LED3 negative polarity				
6	LED4 negative polarity				

Note (1) User's Mating Connector Part No.:

Connector (wire type):FCN(WM13-406-063N) or CviLux(Cl1406M1HRK-NH) or equivalent.

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4.4 LVDS INPUT SIGNAL SPECIFICATIONS

4.4.1 LVDS DATA MAPPING TABLE

LVDS Channel O0	LVDS output	D7	D6	D4	D3	D2	D1	D0
LVD3 Onamilei 00	Data order	OG0	OR5	OR4	OR3	OR2	OR1	OR0
LVDS Channel O1	LVDS output	D18	D15	D14	D13	D12	D9	D8
LVD3 Griannei O1	Data order	OB1	OB0	OG5	OG4	OG3	OG2	OG1
LVDS Channel O2	LVDS output	D26	D25	D24	D22	D21	D20	D19
LVD3 Ghanner O2	Data order	DE	NA	NA	OB5	OB4	OB3	OB2
LVDS Channel O3	LVDS output	D23	D17	D16	D11	D10	D5	D27
LVD3 Griannei O3	Data order	NA	OB7	OB6	OG7	OG6	OR7	OR6
LVDS Channel E0	LVDS output	D7	D6	D4	D3	D2	D1	D0
LVD3 GHAHHEI EU	Data order	EG0	ER5	ER4	ER3	ER2	ER1	ER0
LVDS Channel E1	LVDS output	D18	D15	D14	D13	D12	D9	D8
LVD3 GHannel E1	Data order	EB1	EB0	EG5	EG4	EG3	EG2	EG1
LVDS Channel E2	LVDS output	D26	D25	D24	D22	D21	D20	D19
LVDS Channel E2	Data order	DE	NA	NA	EB5	EB4	EB3	EB2
LVDS Channel E3	LVDS output	D23	D17	D16	D11	D10	D5	D27
LVD3 GHaffilet E3	Data order	NA	EB7	EB6	EG7	EG6	ER7	ER6

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4.4.2 COLOR DATA INPUT ASSIGNMENT

The brightness of each primary color (red, green and blue) is based on the 8-bit gray scale data input for the color. The higher the binary input, the brighter the color. The table below provides the assignment of color versus data input.

												Da	ata	Sigr	nal										
	Color				Re	ed							G	reer	1						Βlι	Je			
	00.0.	R7	R6	R5	R4	R3	R2	R1	R0	G 7	G 6	G 5	G 4	G3	G2	G1	G0	B 7	В6	B5	В4	ВЗ	B2	B 1	B 0
	Black Red	0	0	0	0 1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green	0	0	Ö	0	Ö	Ö	Ö	0	1	1	1	1	1	1	1	1	0	Ö	Ö	ő	Ö	0	0	0
Basic	Blue	0	0	0	0	0	Ö	0	0	Ö	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
Colors	Cyan	0	0	0	0	0	Ö	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Red(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(1)	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gray	Red(2)	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Scale	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Of	_ :	:	:	:	:	:		:		:		:		:	:	:			:		:	:	:	:	
Red	Red(253)	1	1	1	1	1	1	0	1	0	0	0	:0	0	0	0	0	0	0	0	0	0	0	0	:0
	Red(254)	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(255)	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(0) / Dark	0	0	0	0	0	0	0	0	0 0	0	0	0	0	0	0	0	0	0 0	0	0	0	0	0	0
	Green(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0
Gray	Green(2)	0	0	0			0						:	0			0	0	0				0	0	0
Scale	•		:		:	:	:	:			:	:	:	:	:	:	:	:	:	:	:	:		:	
Of	Green(253)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0
Green	Green(254)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0
	Green(255)	0	0	0	0	0	ő	0	0	1	1	1	1	1	1	1	1	0	ő	ő	ő	Ö	0	Ö	0
	Blue(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue(1)	0	0	0	0	0	Ō	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
CHOL	Blue(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
Gray Scale	: '	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Of	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Blue	Blue(253)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1
Diue	Blue(254)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0
	Blue(255)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1

Note (1) 0: Low Level Voltage, 1: High Level Voltage

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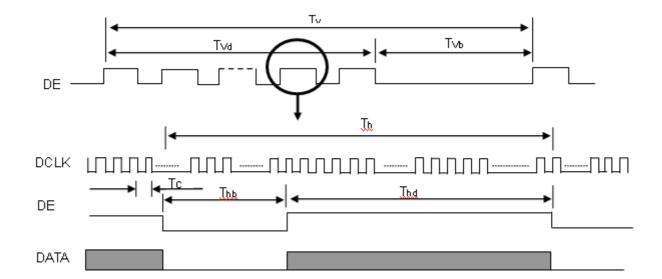
4.5 DISPLAY TIMING SPECIFICATIONS

The input signal timing specifications are shown as the following table and timing diagram.

Signal	Item	Symbol	Min.	Тур.	Max.	Unit	Note	
	Frequency	Fc	58.54	74.25	82.3	MHz	-	
	Period	Tc	ı	13.47		ns		
	Input cycle to cycle jitter	T_{rcl}	-0.02*TC	ı	0.02*TC	ns	(1)	
	Input Clock to data skew	TLVCC S	-0.02*TC		0.02*TC		(2)	
LVDS Clock	Spread spectrum modulation range	Fclkin_ mod	0.97*FC	-	1.03*FC	MHz	(2)	
	Spread spectrum modulation frequency	F _{SSM}	-	1	100	KHz	(3)	
	Frame Rate	Fr	50	60	63	Hz		
	Total	Tv	1115	1125	1136	Th	Tv=Tvd+Tvb	
Vertical Display Term	Active Display	Tvd	1080	1080	1080	Th	-	
	Blank	Tvb	Tv-Tvd	Tv-Tvd	Tv-Tvd	Th	-	
	Total	Th	1050	1100	1150	Tc	Th=Thd+Thb	
Horizontal Display Term	Active Display	Thd	960	960	960	Тс	-	
	Blank	Thb	Th-Thd	Th-Thd	Th-Thd	Tc	-	

Note: Because this module is operated by DE only mode, Hsync and Vsync input signals are ignored.

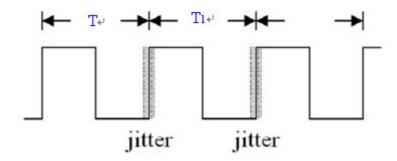
INPUT SIGNAL TIMING DIAGRAM



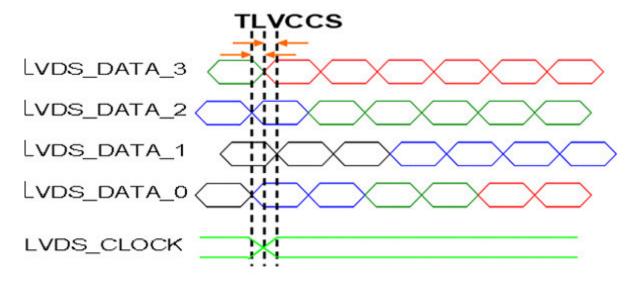
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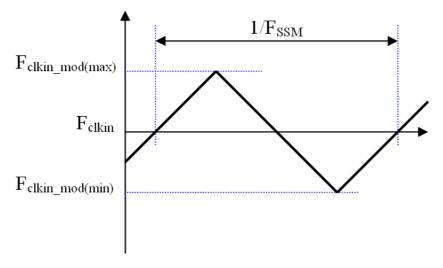
Note (1) The input clock cycle-to-cycle jitter is defined as below figures. Trcl = $IT_1 - TI$



Note (2) Input Clock to data skew is defined as below figures.



Note (3) The SSCG (Spread spectrum clock generator) is defined as below figures.



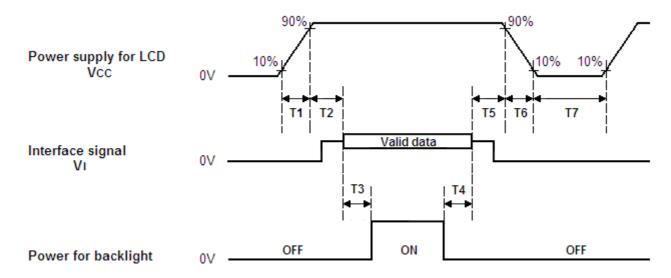
Note(4) The DCLK range at last line of V-blank should be set in 0 to Hdisplay/2

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4.6 POWER ON/OFF SEQUENCE

The power sequence specifications are shown as the following table and diagram.



Timing Specifications:

Parameters		Units		
i arameters	Min	Office		
T1	0.5		10	ms
T2	0	30	50	ms
T3	450			ms
T4	100	250		ms
T5	0	20	50	ms
T6	0.1		100	ms
T7	1000			ms

- Note (1) The supply voltage of the external system for the module input should be the same as the definition of Vcc.
- Note (2) When the backlight turns on before the LCD operation of the LCD turns off, the display may momentarily become abnormal screen.
- Note (3) In case of VCC = off level, please keep the level of input signals on the low or keep a high impedance.
- Note (4) T7 should be measured after the module has been fully discharged between power off and on period.
- Note (5) Interface signal shall not be kept at high impedance when the power is on.
- Note (6) INX won't take any responsibility for the products which are damaged by the customers not following the Power Sequence.
- Note (7) There might be slight electronic noise when LCD is turned off (even backlight unit is also off). To avoid this symptom, we suggest "Vcc falling timing" to follow "t6 spec".

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5. OPTICAL CHARACTERISTICS

5.1 TEST CONDITIONS

Item	Symbol	Value	Unit				
Ambient Temperature	Ta	25 ± 2	°C				
Ambient Humidity	На	50 ± 10	%RH				
Supply Voltage	V_{CC}	5	V				
Input Signal	According to typical value in "3. ELECTRICAL CHARACTERISTICS"						
LED Light Bar Input Current Per Input Pin	I _{PIN}	95	mA _{DC}				
PWM Duty Ratio	D	100	%				
LED Light Bar Test Converter	INX R373B0000U000						

5.2 OPTICAL SPECIFICATIONS

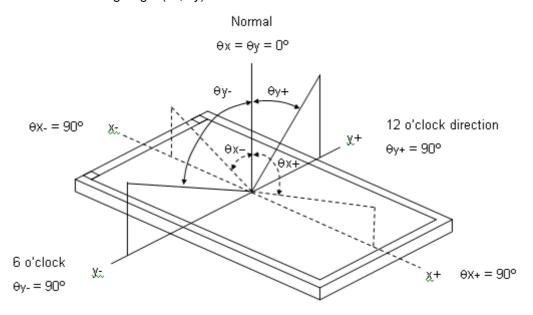
The relative measurement methods of optical characteristics are shown in 5.2. The following items should be measured under the test conditions described in 5.1 and stable environment shown in Note (5).

Ito	em	Symbol	Condition	Min.	Тур.	Max.	Unit	Note
	Red	Rx			0.633			
	neu	Ry			0.340			
	Green	Gx			0.314		+	
Color	diccii	Gy		Тур –	0.632	Тур +		(1) (5)
Chromaticity (CIE 1931)	Dive	Вх		0.03	0.159	0.03	_	(1), (5)
(0.2 1001)	Blue	Ву			0.060			
	\\/\alpha/\alpha:\	Wx			0.313			
	White	Wy			0.329			
	Center Luminance of White (Center of Screen)			200	250	-		(4), (5)
Contra	st Ratio	CR		2000	3000			(2), (5)
Response Time	Gray to Gray	T _{GtG_AVE}	$\theta_x=0^\circ, \ \theta_Y=0^\circ$	-	10	16	ms	(3)
White Variation		W		72	75	-	-	(5), (6)
Viewing Angle	Horizontal	$\theta x - + \theta x +$	CR ≧ 10	160	178		Deg.	(1), (5)
viewing Angle	Vertical	θ y- + θ y+	Un ≦ 10	160	178		טפט.	(1), (3)

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Note (1) Definition of Viewing Angle (θx , θy):



Note (2) Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

Contrast Ratio (CR) = L255 / L0

L255: Luminance of gray level 255

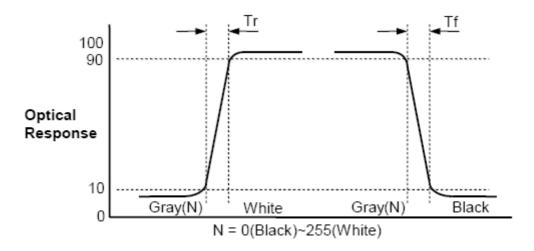
L 0: Luminance of gray level 0

CR = CR(5)

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note (6).

Note (3) Definition of Gray to Gray Response Time:

G to G(BW) Response time is defined as the following figure and shall be measured by switching the input signal for "Gray(N)" and "Black or White".

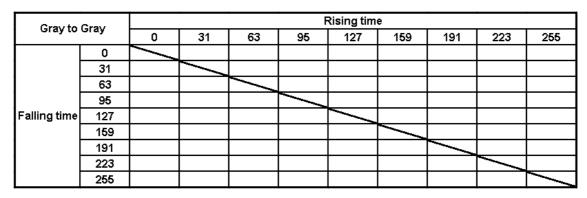


The Gray to Gray response time is defined as the following figure and shall be measured by switching the input signal for "Gray To Gray ".

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- T_{GtG AVE} is the total average time at rising time and falling time for "Gray To Gray".
- If system use ODC (Over Driving Circuit) function, T_{GtG AVE} may be 5ms~8ms.
- * It depends on Overshoot rate.



Note (4) Definition of Luminance of White (L_C):

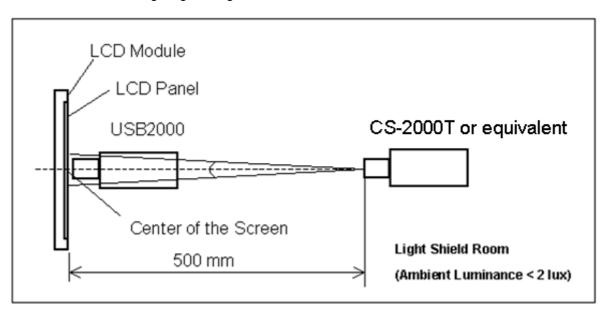
Measure the luminance of gray level 255 at center point

$$L_{C} = L(5)$$

L(x) is corresponding to the luminance of the point X at Figure in Note (6).

Note (5) Measurement Setup:

The LCD module should be stabilized at given temperature for 40 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 40 minutes in a windless room.



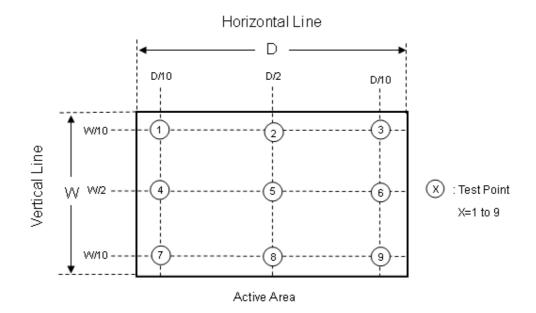
Note (6) Definition of White Variation (δW):

Measure the luminance of gray level 255 at 9 points

 $\delta W = (Minimum [L (1) \sim L (9)] / Maximum [L (1) \sim L (9)]) *100%$

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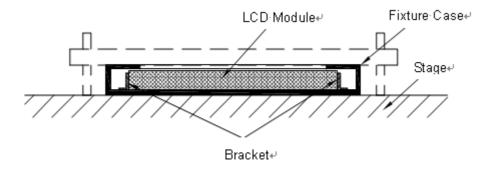


6. RELIABILITY TEST ITEM

Items	Required Condition	Note
Temperature Humidity Bias (THB)	Ta= 50°C , 80%RH, 240hours	
High Temperature Operation (HTO)	Ta= 50°C , 240hours	
Low Temperature Operation (LTO)	Ta= 0°C , 240hours	
High Temperature Storage (HTS)	Ta= 60° C , 240hours	
Low Temperature Storage (LTS)	Ta= -20 $^{\circ}$ C , 240hours	
	Acceleration: 1.5 G Wave: Sine	
Vibration Test	Frequency: 10 - 300 Hz	
(Non-operation)	Sweep: 30 Minutes each Axis (X, Y, Z)	
	Acceleration: 50 G Wave: Half-sine Active Time: 11 ms	
Shock Test (Non-operation)	Direction : ± X, ± Y, ± Z.(one time for each Axis)	
Thermal Shock Test (TST)	-20°C/30min , 60°C / 30min , 100 cycles	
On/Off Test	25℃ ,On/10sec , Off /10sec , 30,000 cycles	
ESD (Electro Static Discharge)	Contact Discharge: ± 8KV, 150pF(330Ω)	
	Air Discharge: \pm 15KV, 150pF(330 Ω)	
Altitude Test	Operation:10,000 ft / 24hours Non-Operation:30,000 ft / 24hours	

- Note (1) criteria: Normal display image with no obvious non-uniformity and no line defect.
- Note (2) Evaluation should be tested after storage at room temperature for more than two hour
- Note (3) At testing Vibration and Shock, the fixture in holding the module has to be hard and rigid enough so that the module would not be twisted or bent by the fixture.

The fixing condition is shown as below:



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7.PACKING

7.1 PACKING SPECIFICATIONS

(1) LCD 11 modules / 1 Box

(2) Box dimensions: 620(L) X 348(W) X 430(H) mm

(3) Weight: approximately: 33kg (11modules per box)

7.2 PACKING METHOD

(1) Carton Packing should have no failure in the following reliability test items.

Test Item	Test Conditions	Note	
	ISTA STANDARD		
	Random, Frequency Range: 1 – 200 Hz		
Vibration	Top & Bottom: 30 minutes (+Z), 10 min (-Z),	Non Operation	
	Right & Left: 10 minutes (X)	·	
	Back & Forth 10 minutes (Y)		
Dropping Test	1 Corner, 3 Edge, 6 Face,(31)cm	Non Operation	

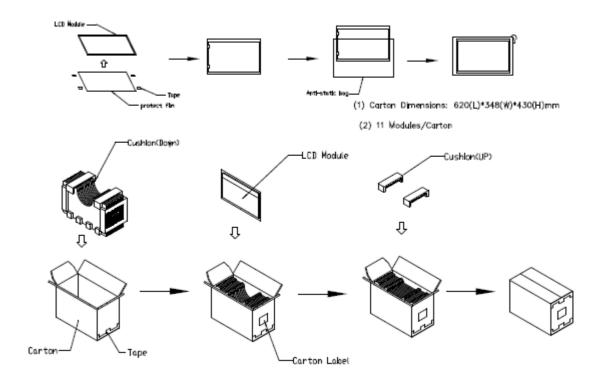


Figure. 7-1 Packing method

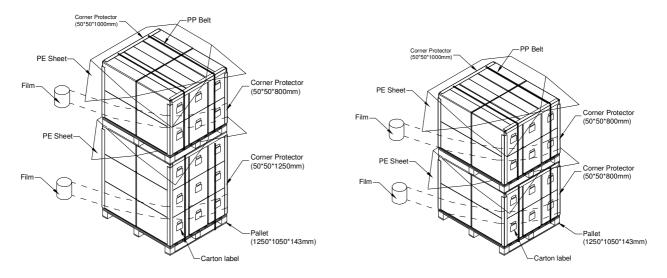
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7.3 PALLET

For ocean shipping

Sea / Land Transportation (40ft HQ Container) Sea / Land Transportation (40ft Container)



For air transport

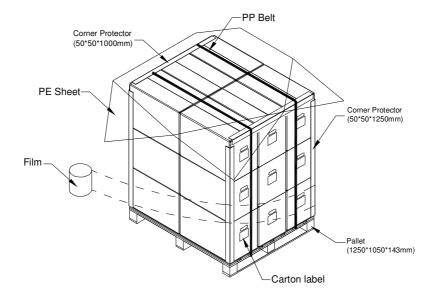


Figure. 7-2 Packing method

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8. INX MODULE LABEL

The barcode nameplate is pasted on each module as illustration, and its definitions are as following explanation.



(a) Model Name: M236HJJ-L30

(b) Revision: Rev. XX, for example: A0, A1... B1, B2... or C1, C2...etc.

(c) INX barcode definition:

Serial ID: XX-XX-XX-YMD-L-NNNN

Code	Meaning	Description
XX	INX internal use	-
XX	Revision	Cover all the change
Х	INX internal use	-
XX	INX internal use	-
YMD	Year, month, day	Year: 0~9, 2001=1, 2002=2, 2003=32010=0, 2011=1, 2012=2 Month: 1~12=1, 2, 3, ~, 9, A, B, C Day: 1~31=1, 2, 3, ~, 9, A, B, C, ~, W, X, Y, exclude I, O, and U.
L	Product line #	Line 1=1, Line 2=2, Line 3=3,
NNNN	Serial number	Manufacturing sequence of product

(d) Customer's barcode definition:

Serial ID: CM- N6J30-X-X-X-XX-L-XX-L-YMD-NNNN

Code	Meaning	Description	
CM	Supplier code	INX=CM	
N6J30	Model number	M236HJJ-L30	
Х	Revision code	Non ZBD: 1,2,~,8,9 / ZBD: A~Z	
Х	Source driver IC code	Century=1, CLL=2, Demos=3, Epson=4, Fujitsu=5, Himax=6, Hitachi=7, Hynix=8, LDI=9, Matsushita=A, NEC=B, Novatek=C, OKI=D, Philips=E, Renasas=F, Samsung=G, Sanyo=H, Sharp=I, TI=J, Topro=K, Toshiba=L, Windbond=M, ILITEK=Q, Fiti=Y, None IC =Z	
Х	Gate driver IC code		
XX	Cell location	Tainan Taiwan=TN, Ningbo China=CN, Hsinchu Taiwan=SC	
L	Cell line #	1,2,~,9,A,B,~,Y,Z	
XX	Module location	Tainan, Taiwan=TN ; Ningbo China=NP ; Shenzhen China=SH ; Nanhai China=NH	
L	Module line #	1,2,~,9,A,B,~,Y,Z	
YMD	Year, month, day	Year: 0~9, 2001=1, 2002=2, 2003=32010=0, 2011=1, 2012=2 Month: 1~12=1, 2, 3, ~, 9, A, B, C Day: 1~31=1, 2, 3, ~, 9, A, B, C, ~, T, U, V	
NNNN	Serial number	By LCD supplier	

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(e) FAB ID(UL Factory ID):

Region	Factory ID
TWINX	GEMN
NBCMI	LEOO
NBCMI	VIRO
NBCME	CANO
NHCMI	CAPG

9. PRECAUTIONS

9.1 ASSEMBLY AND HANDLING PRECAUTIONS

- (1) Do not apply rough force such as bending or twisting to the module during assembly.
- (2) To assemble or install module into user's system can be only in clean working areas. The dust and oil may cause electrical short or worsen the polarizer.
- (3) It's not permitted to have pressure or impulse on the module because the LCD panel and Backlight will be damaged.
- (4) Always follow the correct power sequence when LCD module is connecting and operating. This can prevent damage to the CMOS LSI chips during latch-up.
- (5) Do not pull the I/F connector in or out while the module is operating.
- (6) Do not disassemble the module.
- (7) Use a soft dry cloth without chemicals for cleaning, because the surface of polarizer is very soft and easily scratched.
- (8) It is dangerous that moisture come into or contacted the LCD module, because moisture may damage LCD module when it is operating.
- (9) High temperature or humidity may reduce the performance of module. Please store LCD module within the specified storage conditions.
- (10)When ambient temperature is lower than 10°C may reduce the display quality. For example, the response time will become slowly.
- (11) Do not press or scratch the surface harder than a HB pencil lead on the panel because the polarizer is very soft and easily scratched.

9.2 STORAGE PRECAUTIONS

- (1) Do not leave the module in high temperature, and high humidity for a long time. It is highly recommended to store the module with temperature from 0°C to 35°C and relative humidity of less than 70%
- (2) Do not store the TFT LCD module in direct sunlight
- (3) The module should be stored in dark place. It is prohibited to apply sunlight or fluorescent light in storing

9.3 OPERATION PRECAUTIONS

(1) The LCD product should be operated under normal condition.

Normal condition is defined as below:

Temperature : 20±15°C





Humidity: 65±20%

Display pattern: continually changing pattern(Not stationary)

(2) If the product will be used in extreme conditions such as high temperature, high humidity, high altitude, display pattern or operation time etc... It is strongly recommended to contact INX for application engineering advice. Otherwise, Its reliability and function may not be guaranteed.

9.4 SAFETY PRECAUTIONS

- (1) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, skin or clothes, it has to be washed away thoroughly with soap.
- (2) After the module's end of life, it is not harmful in case of normal operation and storage.

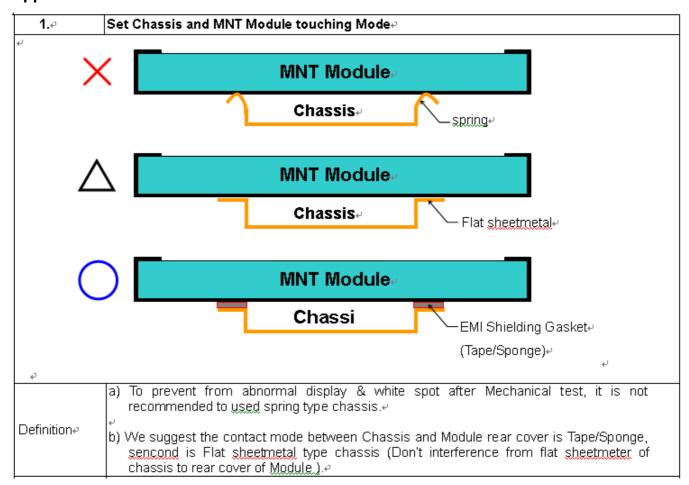
9.5 SAFETY STANDARDS

The LCD module should be certified with safety regulations as follows:

- (1) UL60950-1 or updated standard.
- (2) IEC60950-1 or updated standard.

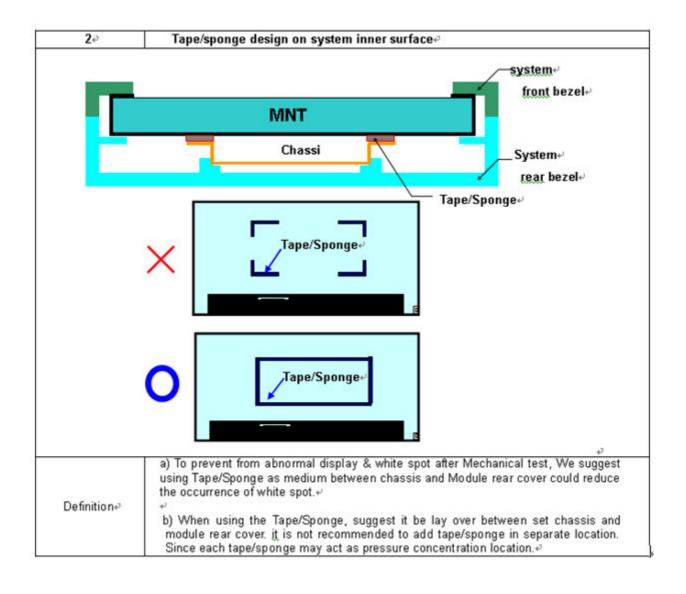
9.6 OTHER

Appendix 1. SYSTEM COVER DESIGN NOTICE



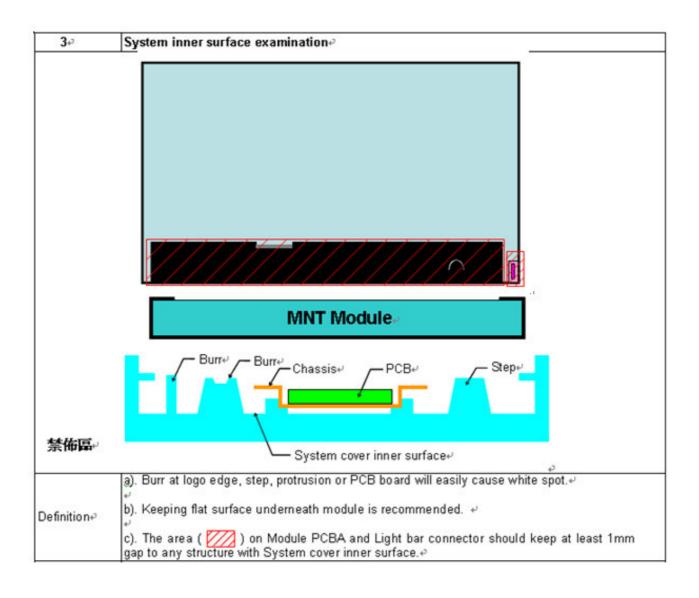
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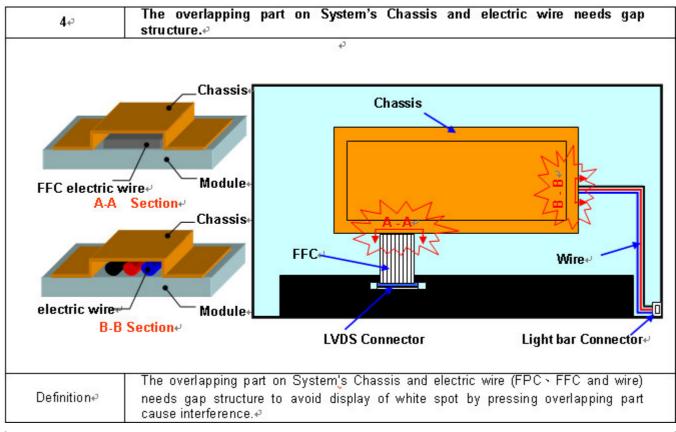
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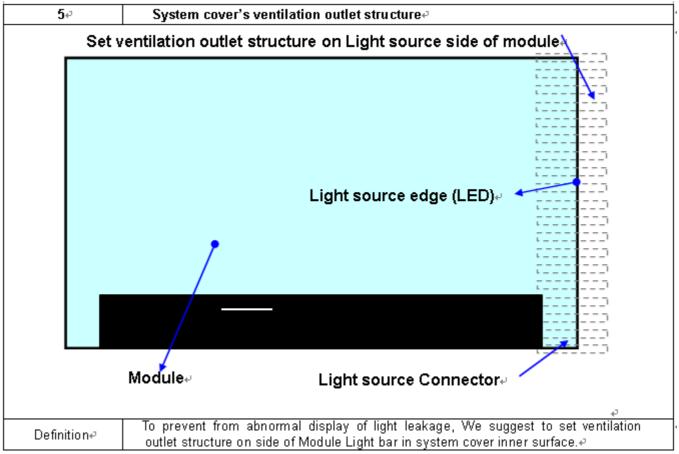




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Appendix 2. OUTLINE DRAWING

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